



#3/A  
4-17-02  
Mehlisch

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Bily WANG, Bill CHANG and Yuan LEE

Art unit: 2814

Serial No. 09/922,688

Examiner: FARAHANI, Dana

Filed: Aug. 7, 2001

For: LED FOCUSING CUP IN A STACKED SUBSTRATE

AMENDMENT (clear version)

Commissioner of Patents  
Washington, D.C. 20231

Sir:

In response to USPTO communication dated March 4, 2002, please amend the application as follows:

IN THE CLAIMS:

Please cancel claim 1.

Please rewrite claim 2 as follows:

A1 --2. (once amended) A method for fabricating a focusing cup for an optoelectronic device package comprising the steps of:

forming a through hole in an upper insulating substrate, wherein said through hole is of conical shape;

stacking said upper insulating substrate over a lower insulating substrate; and

mounting an optoelectronic device on said lower substrate inside said through hole.--

Please cancel claim 5.

Please rewrite claims 6 and 7 as follows:

A2 --6. (once amended) The method as described in claim 2, wherein said optoelectronic device has two top electrodes wire-bonded respectively to two bonding pads mounted on top of said upper substrate.

~~and 6~~ 7. (once amended) The method as described in claim 2, ~~further comprising a step of inserting a metallic plate between said optoelectronic device and said lower substrate to enhance light reflection.~~--

Please rewrite claim 9 as follows:

A3 --9 (once amended) The method as described in claim 2, further comprising the step of lining the wall of said through hole with metal coating to enhance light reflection.--

Please cancel claim 13.

Please rewrite claim 14 as follows:

RECEIVED  
APR 11 2002  
TECHNOLOGY CENTER 2800